

Description

The FME-230B is a 150 V, 30 A Schottky diode with allowing improvements in V_F and I_R characteristics.

These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

Features

• V _{RM}	150 V
• I _{F(AV)}	30 A
• $V_F (I_F = 15 \text{ A})$	
Bare Lead Frame: Ph-free (• •

Bare Lead Frame: Pb-free (RoHS Compliant)

• Flammability: Equivalent to UL94V-0

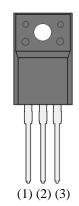
Applications

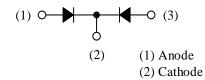
High speed switching applications as follows:

- DC-DC Converter
- Adapter

Package

TO220F-3L





Not to scale

(3) Anode

FME-230B

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage ⁽¹⁾	V_{RSM}		150	V
Repetitive Peak Reverse Voltage ⁽¹⁾	V_{RM}		150	V
Average Forward Current	I _{F(AV)}	See Figure 1 and Figure 2	30	A
Surge Forward Current ⁽¹⁾	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	150	A
I ² t Limiting Value ⁽¹⁾	I^2t	$1 \text{ ms} \le t \le 10 \text{ ms}$	112	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

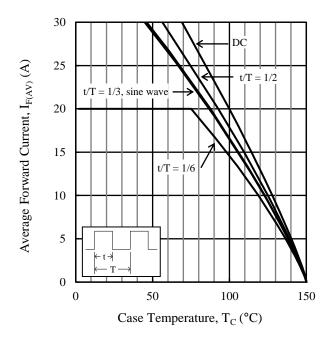
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop ⁽¹⁾	V_{F}	$I_F = 15 A$	_	0.90	0.95	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	_	_	300	μΑ
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$			75	mA
Thermal Resistance ⁽²⁾	$R_{\text{th(J-C)}}$		_	_	4.0	°C/W

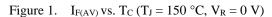
Mechanical Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Heatsink Mounting Screw Torque		0.490	_	0.686	N·m
Package Weight			1.8	_	g

 $^{^{(1)}}$ Specifies a value per chip; the FME-230B consists of two chips. $^{(2)}$ R_{th (J-C)} is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Derating Curves





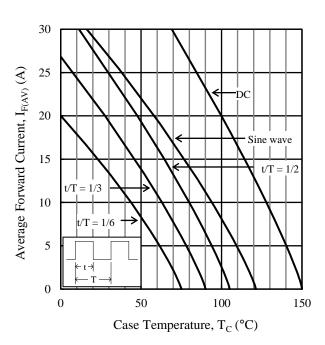


Figure 2. $I_{F(AV)}$ vs. T_C ($T_J = 150$ °C, $V_R = 150$ V)

Characteristic Curves

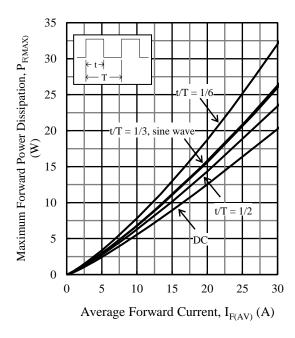


Figure 3. $P_{F(MAX)}$ vs. $I_{F(AV)}$ ($T_J = 150$ °C)

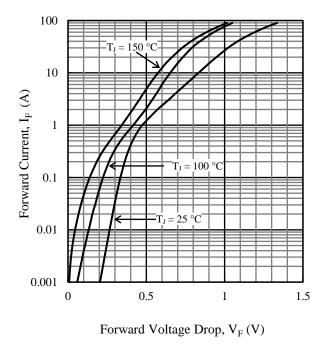


Figure 5. Typical Characteristics: I_F vs. V_F

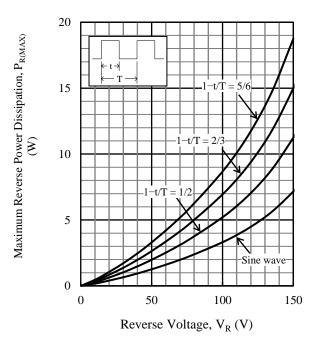


Figure 4. $P_{R(MAX)}$ vs. V_R ($T_J = 150$ °C)

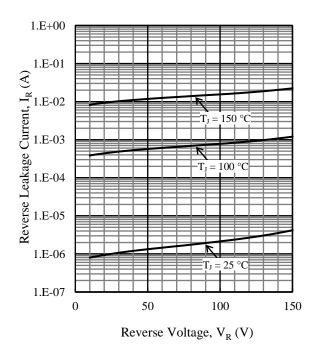


Figure 6. Typical Characteristics: I_R vs. V_R

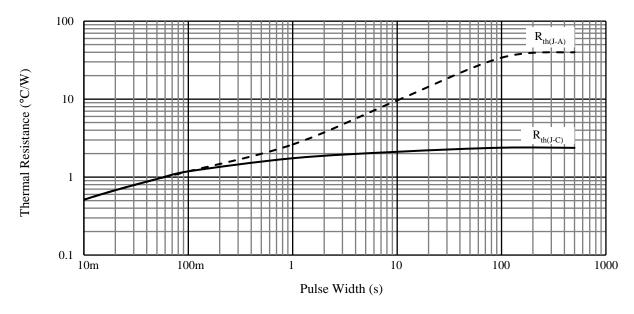
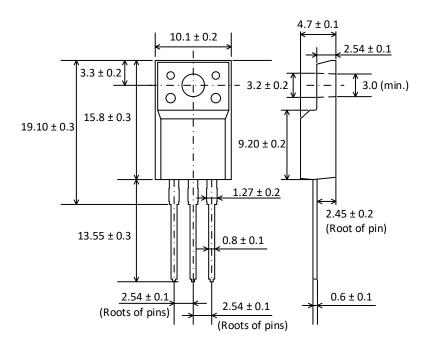


Figure 7. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• TO220F-3L



NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: 260 °C / 10 s, 1 time

Soldering Iron: 350 °C / 3.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

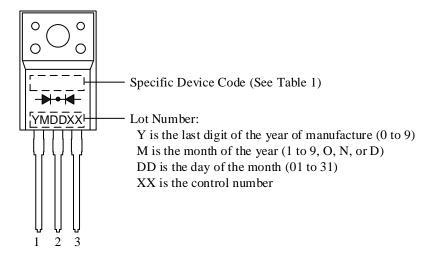


Table 1. Specific Device Code

Specific Device Code	Part Number
E230B	FME-230B

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